



Rectifier Diode

Target Information

DS5408-2.0 October 2001

Replaces November 2000, version DS5408-1.1

FEATURES

- Optimised For High Current Rectifiers
- High Surge Capability
- Very Low On-state Voltage

APPLICATIONS

- Electroplating
- Power Supplies
- Welding

VOLTAGE RATINGS

| Part and Ordering Number | Repetitive Peak Reverse Voltage V _{RRM} V | Conditions |
|-----------------------------|---|---------------------|
| RD65FV06 | 600 | $V_{RSM} = V_{RRM}$ |
| RD65FV05 | 500 | KSW KKW |
| RD65FV04 | 400 | |
| RD65FV03 | 300 | |
| RD65FV02 | 200 | |
| RD65FV01 | 100 | |

ORDERING INFORMATION

When ordering, select the required part number shown in the Voltage Ratings selection table.

For example:

RD65FV04

Note: Please use the complete part number when ordering and quote this number in any future correspondance relating to your order.

KEY PARAMETERS

| V_{RRM} | | 600V |
|--------------------|-------|---------|
| I _{F(AV)} | (max) | 11745A |
| I _{FSM} | (max) | 162000A |

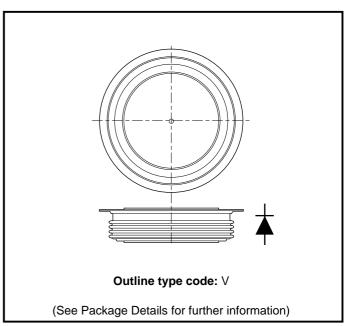


Fig. 1 Package outline



CURRENT RATINGS

$T_{case} = 75$ °C unless otherwise stated

| Symbol | Parameter | Conditions | Max. | Units | | | |
|---------------------|-------------------------------------|--------------------------|-------|-------|--|--|--|
| Double Sic | Double Side Cooled | | | | | | |
| I _{F(AV)} | Mean forward current | Half wave resistive load | 11745 | А | | | |
| I _{F(RMS)} | RMS value | - | 18450 | А | | | |
| l _F | Continuous (direct) forward current | - | 16974 | Α | | | |
| Single Side | Single Side Cooled (Anode side) | | | | | | |
| I _{F(AV)} | Mean forward current | Half wave resistive load | 7632 | Α | | | |
| I _{F(RMS)} | RMS value | - | 11988 | Α | | | |
| I _F | Continuous (direct) forward current | - | 10079 | Α | | | |

$T_{case} = 85^{\circ}C$ unless otherwise stated

| Symbol | Parameter | Test Conditions | Max. | Units | | | |
|---------------------|-------------------------------------|--------------------------|-------|-------|--|--|--|
| Double Sid | Double Side Cooled | | | | | | |
| I _{F(AV)} | Mean forward current | Half wave resistive load | 11120 | А | | | |
| I _{F(RMS)} | RMS value | - | 17500 | А | | | |
| I _F | Continuous (direct) forward current | - | 16000 | А | | | |
| Single Side | Single Side Cooled | | | | | | |
| I _{F(AV)} | Mean forward current | Half wave resistive load | 7200 | А | | | |
| I _{F(RMS)} | RMS value | - | 11300 | А | | | |
| I _F | Continuous (direct) forward current | - | 9450 | А | | | |



SURGE RATINGS

| Symbol | Parameter | Test Conditions | Max. | Units |
|------------------|--|---|------------------------|------------------|
| I _{FSM} | Surge (non-repetitive) forward current | 10ms half sine, T _{case} = 175°C | 130 | kA |
| l²t | I ² t for fusing | $V_{R} = 50\% V_{RRM} - 1/4 \text{ sine}$ | 84.5 x 10 ⁶ | A²s |
| I _{FSM} | Surge (non-repetitive) forward current | 10ms half sine, T _{case} = 175°C | 162 | kA |
| l ² t | I ² t for fusing | V _R = 0 | 132 x 10 ⁶ | A ² s |

THERMAL AND MECHANICAL RATINGS

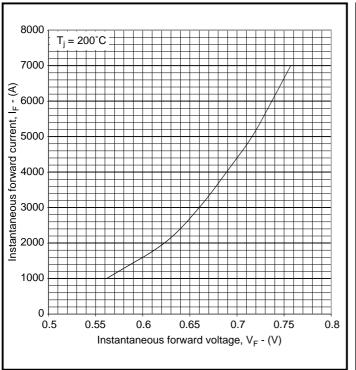
| Symbol | Parameter | Test Conditions | | Min. | Max. | Units |
|----------------------|---------------------------------------|--------------------------|-------------|-------------|--------|-------|
| R _{th(j-c)} | Thermal resistance - junction to case | Double side cooled | DC | - | 0.0075 | °CW |
| | | Single side cooled | Anode DC | - | 0.015 | °CW |
| | | | Cathode DC | - | 0.015 | °CW |
| R _{th(c-h)} | Thermal resistance - case to heatsink | Clamping force 43.0kN | Double side | - | 0.002 | °CW |
| | | (with mounting compound) | Single side | - | 0.004 | °CW |
| T _{vj} | Virtual junction temperature | Forward (conducting) | | - | 225 | °C |
| | | Reverse (blocking) | | - | 200 | °C |
| T _{stg} | Storage temperature range | | | - 55 | 200 | °C |
| F _m | Clamping force | | | 38.7 | 47.3 | kN |

CHARACTERISTICS

| Symbol | Parameter | Test Conditions | Min. | Max. | Units |
|-----------------|-------------------------------|---|------|--------|-------|
| I _{RM} | Peak reverse current | At V _{RRM} , T _{case} = 200°C | - | 150 | mA |
| I _{rr} | Peak reverse recovery current | $I_F = 2000A$, $dI_{RR}/dt = 3A/\mu s$, | - | 230 | Α |
| Q _s | Total stored charge | $T_{case} = 200^{\circ}C, V_{R} = 100V$ | - | 39 | μС |
| V _{TO} | Threshold voltage | At T _{vj} = 200°C | - | 0.6 | V |
| r _T | Slope resistance | At T _{vj} = 200°C | - | 0.0225 | mΩ |



CURVES



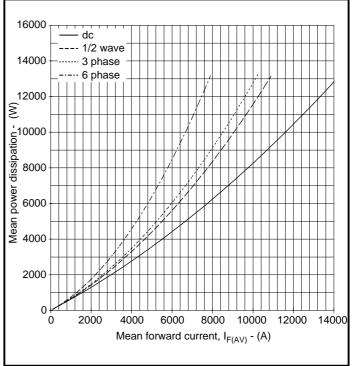


Fig. 2 Maximum (limit) forward characteristics

Fig. 3 Power dissipation

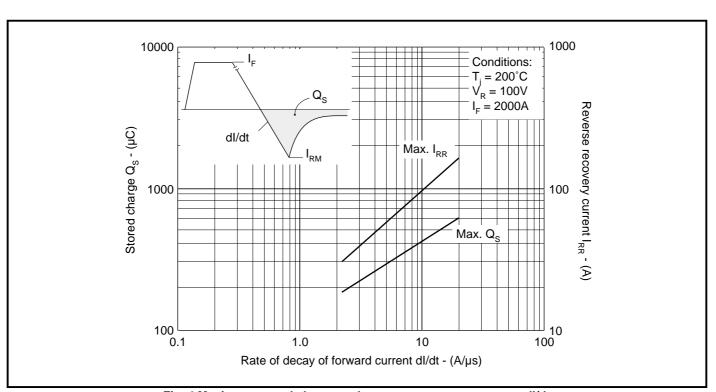
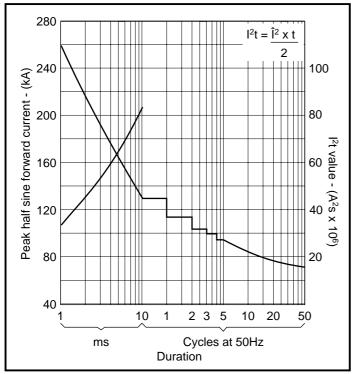
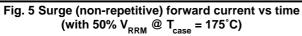


Fig. 4 Maximum stored charge and reverse recovery current vs dl/dt





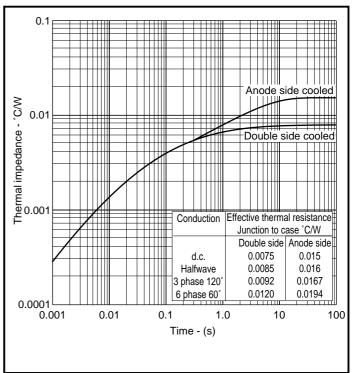
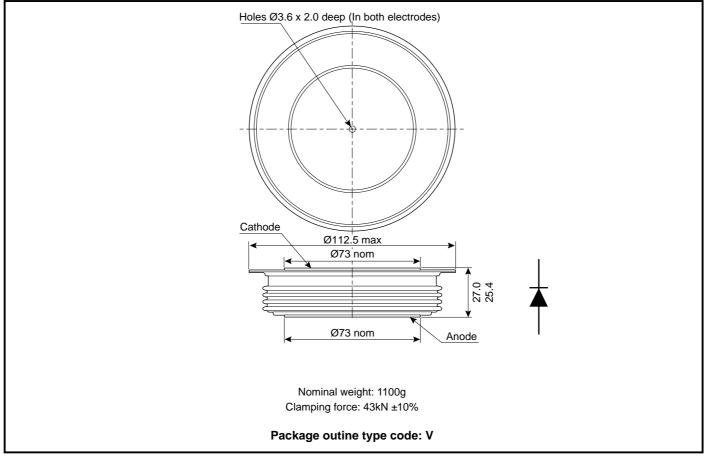


Fig. 6 Maximum (limit) transient thermal impedance



PACKAGE DETAILS

For further package information, please visit our website or contact your nearest Customer Service Centre. All dimensions in mm, unless stated otherwise. DO NOT SCALE.



Note:

1. Package maybe supplied with pins and/or tags.



POWER ASSEMBLY CAPABILITY

The Power Assembly group was set up to provide a support service for those customers requiring more than the basic semiconductor, and has developed a flexible range of heatsink / clamping systems in line with advances in device types and the voltage and current capability of our semiconductors.

We offer an extensive range of air and liquid cooled assemblies covering the full range of circuit designs in general use today. The Assembly group continues to offer high quality engineering support dedicated to designing new units to satisfy the growing needs of our customers.

Using the up to date CAD methods our team of design and applications engineers aim to provide the Power Assembly Complete solution (PACs).

DEVICE CLAMPS

Disc devices require the correct clamping force to ensure their safe operation. The PACs range offers a varied selection of pre-loaded clamps to suit all of our manufactured devices. This include cube clamps for single side cooling of 'T' 22mm

Clamps are available for single or double side cooling, with high insulation versions for high voltage assemblies.

Please refer to our application note on device clamping, AN4839

HEATSINKS

Power Assembly has its own proprietary range of extruded aluminium heatsinks. They have been designed to optimise the performance or our semiconductors. Data with respect to air natural, forced air and liquid cooling (with flow rates) is available on request.

For further information on device clamps, heatsinks and assemblies, please contact your nearest Sales Representative or Customer Services.



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Preliminary Information: The product is in design and development. The datasheet represents the product as it is understood but details may change.

Advance Information: The product design is complete and final characterisation for volume production is well in hand.

No Annotation: The product parameters are fixed and the product is available to datasheet specification.

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